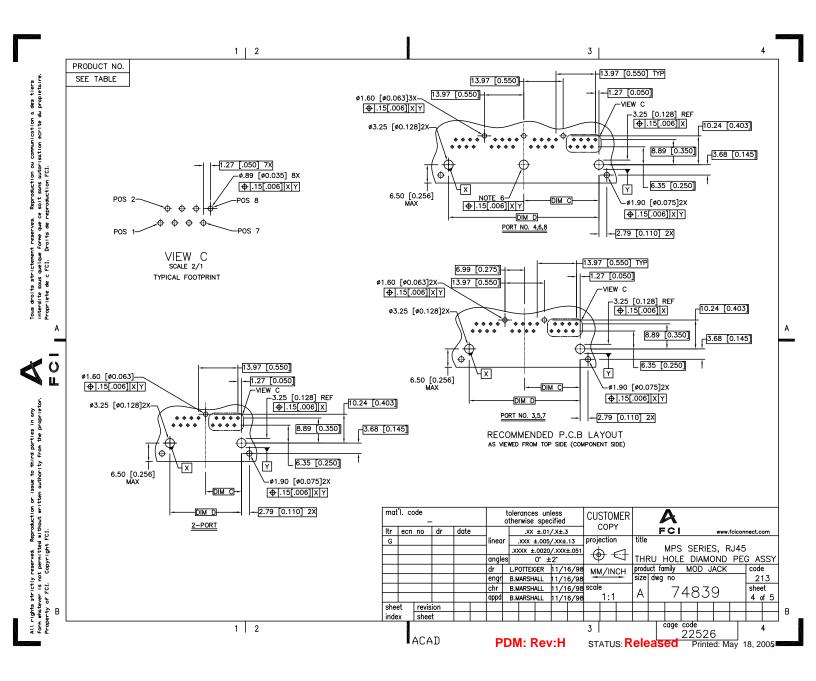


			1 2	1	1	ļ			3			
PRODUCT NO	NO. OF PORTS	DIM A ^{+.60[.024]}	DIM B	DIM C ±.10 [±.004]	DIM D ±.15 [±.006]	DIM E (±.13	5]					
74839-X02	(2	31.68 [1.247]	13.97 [0.550]	12.70 [0.500]	25.40 [1.000]	32.11 [1.26	4]					
74839–X03	1 3	45.65 [1.797]	27.94 [1.010]	19.69 [0.775]	39.37 [1.550]	46.08 [1.81	4]					
74839-X04	r 4	59.62 [2.347]	41.91 [1.650]	26.67 [1.050]	53.34 [2.100]	60.05 [2.36	4]					
74839-X05	r 5	73.59 [2.897]	55.88 [2.200]	33.66 [1.325]	67.31 [2.650]	74.02 [2.91	4]					
74839-X06	r 6	87.56 [3.447]	69.85 [2.750]	40.64 [1.600]	81.28 [3.200]	87.99 [3.46	4]					
74839-X07	(7	101.53 [3.997]	83.82 [3.300]	47.63 [1.875]	95.25 [3.750]	101.96 [4.0	14] NC	TE: PLEASE CHECK	FOR AVAIL	ABILITY,		
74839- <u>X</u> 08	(8	115.50 [4.547]	97.79 [3.850]	54.61 [2.150]	109.22 [4.300]	115.93 [4.5	64]	NOT ALL OPTIC	NS AVAILA	BLE.		
T						-						
	PRING OPTION Y DESCRIPTION (SEE SHEET 5 FOR OPTIONAL VIEWS)					NOTES	5:					
	1	SPRING ON TOP, BOTTOM AND BOTH SIDES				1. HOUSING MATL: HIGH TEMP. THERMOPLASTIC, COLOR BLACK,						
	2	NO SPRINGS SPRINGS ON TOP AND BOTTOM				UL94V-0. 2. CONTACT MATL: COPPER ALLOY MATING AREA PLATING: Au OVER NI., (SEE TABLE). SOLDER AREA PLATING: 2.54uM/100u" MIN TIN LEAD OVER NI. LEAD FREE OPTION:						
	4	SPRINGS ON TOP AND BOTTOM SPRINGS ON TOP,BOTTOM AND 1 PER SIDE (STAGGERED)										
	5	SAME AS OPTION 4 EXCEPT OPPOSITE STAGGER										
								AREA PLATING: 2.	54uM/100u"	MIN PURE	TIN OVER N	Ni.
PLATING CO		PLATING 11 1/30u" G.X.T.				3. SH	HIELDING	MAT'L: TIN PLATE	COPPER	ALLOY.		
3		1/30u" GOLD						IONS IN MILLIMETER				
5	1.27u	M/50u" GOLD						5 FOR GROUND TA				
						ě				ATION.		
						Š		G FOR 8 PORT ON				
						<u> </u>		OGO LOCATED IN T				
						 (8) ADD LF SUFFIX AT THE END OF PART NUMBER FOR LEAD FREE OPTION 9. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERA 						
		5 2		R .25[0.0		FC	OR 15 SE	CONDS IN A WAVE	SOLDER A	PLICATION	WITH A 1.5	mm
-	[′	,				HICK CIRCUIT BOAF RE AVAILABLE.	RD. SEE API	LICATION NO	TES/PROCE	DUR
		((_
14.22 [0.	560]))						JCT MEETS EUROP REGULATION AS DE				R
14.22 [0.	500]	((PCB FLU			ATING OF					
))		BOLIOM	OF OPENING	<u></u> МА	AY BE EIT	HER GOLD OR GX	T PLATED A	T MANUFAC	TURER'S OF	PTIO
<u> </u>	_ ,	/[<u> </u>								
		1		{	mat	. code		tolerances unless	CUSTOMER	Λ		
	RECOM	IMENDED PA	NEL OPEN	ING			data	otherwise specified	COPY	A		
					н Н	ecn no dr	date line	.XX ±.01/.X±.3	projection	title	www.fci	
							an	.XXXX ±.0020/.XXX±.05 gles 0* ±2*		MPS	SERIES, RJ	
							dr	L.POTTEIGER 11/16/9	MM/INCH	product family	MOD JACK	C
					\square		eng		8	size dwg no	4070	s
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